SPECIFICATIONS FOR NICHIA CHIP TYPE WHITE LED MODEL : NASW031AT

NICHIA CORPORATION

. . . .

1.SPECIFICATIONS

1) Absolute Maximum Rating	Ta=25°C)			
Item		Symbol	Absolute Maximum Rating	Unit
Forward Current	**	IF	30	mA
Pulse Forward Current	* **	IFP	100	mA
Reverse Voltage	**	VR	5	V
Total Power Dissipation	***	Ptot	210	mW
Operating Temperature		Topr	-30 ~ + 85	°C
Storage Temperature		Tstg	-40 ~ +100	°C
Soldering Temperature		Tsld	Reflow Soldering : 260°C	for 10sec.
			Hand Soldering : 350°C	for 3sec.

IFP Conditions : Pulse Width ≤ 10 msec. and Duty $\leq 1/10$ *

Rating per one circuit. **

******* Rating for total power dissipation when two circuits are lit simultaneously.

(2) Initial Electrical/Optical Characteristics	
------------------------------------------------	--

Initial Electrical/Optical Characteristics (Ta=25°C)							
Item		Symbol	Condition	Тур.	Max.	Unit	
Forward Voltage		VF	IF=20mA/one circuit	(3.2)	3.5	V	
Reverse Current		Ir	V _R = 5V/one circuit	-	50	μA	
Luminous Intensity		Iv	IF=20mA/one circuit Two circuits are lit simultaneously.	(4100)	-	mcd	
Chromaticity Coordinate* x y		-	IF=20mA/one circuit Two circuits are lit	0.31	-	-	
		_	simultaneously.	0.32	-	_	

* Please refer to CIE 1931 chromaticity diagram.

(3	3) Ranking					(Ta	a=25°C)
	Item		Symbol	Condition	Min.	Max.	Unit
		Rank V	Iv	IF=20mA/one circuit	5000	7200	mcd
	Luminous Intensity	Rank U	Iv	Two circuits are lit	3600	5000	mcd
		Rank T	Iv	simultaneously.	2500	3600	mcd

* Luminous Intensity Measurement allowance is $\pm 10\%$.

Color	Ranks
-------	-------

(IF=20mA/one circuit Two circuits are lit simultaneously. Ta=25°C)

	Rank a0							
Х	0.280	0.296						
у	0.248	0.267	0.305	0.276				
		Rank b2						
х	0.296	0.287	0.330	0.330				
у	0.276	0.295	0.339	0.318				

		Rank b1					
Х	0.287	0.283	0.330	0.330			
у	0.295	0.305	0.360	0.339			

)	0.220	0.000	0.200	0.000		
Rank c0						
Х	0.330	0.330	0.361	0.356		
У	0.318	0.360	0.385	0.351		

* Color Coordinates Measurement allowance is ± 0.01 .

2.INITIAL OPTICAL/ELECTRICAL CHARACTERISTICS Please refer to figure's page.

3.OUTLINE DIMENSIONS AND MATERIALS

Please refer to figure's page.

s;	Package	:	Heat-Resistant Polymer
	Encapsulating Resin	:	Epoxy Resin (with Diffused + Phosphor)
	Electrodes	:	Ag Plating Copper Alloy

4.PACKAGING

 \cdot The LEDs are packed in cardboard boxes after taping.

Please refer to figure's page.

The label on the minimum packing unit shows ; Part Number, Lot Number, Ranking, Quantity

- \cdot In order to protect the LEDs from mechanical shock, we pack them in cardboard boxes for transportation.
- \cdot The LEDs may be damaged if the boxes are dropped or receive a strong impact against them, so precautions must be taken to prevent any damage.
- The boxes are not water resistant and therefore must be kept away from water and moisture.
- · When the LEDs are transported, we recommend that you use the same packing method as Nichia.

5.LOT NUMBER

The first six digits number shows lot number.

The lot number is composed of the following characters;

 $\bigcirc \Box \times \times \times \times - \bigtriangleup \blacksquare$

- - Year (5 for 2005, 6 for 2006)
- $\hfill\square$ Month (1 for Jan., 9 for Sep., A for Oct., B for Nov.)

 $\times \times \times \times$ - Nichia's Product Number

- \triangle Ranking by Color Coordinates
- Ranking by Luminous Intensity

6.RELIABILITY (1) TEST ITEMS AND RESULTS

(1) IEST ITENIS AND KE	Standard			Number of
Test Item	Test Method	Test Conditions	Note	Damaged
Resistance to	JEITA ED-4701	Tsld=260°C, 10sec.	2 times	0/50
Soldering Heat	300 301	(Pre treatment 30°C,70%,168hrs.)		
(Reflow Soldering)				
Solderability	JEITA ED-4701	Tsld= $215 \pm 5^{\circ}$ C, 3sec.	1 time	0/50
(Reflow Soldering)	300 303	(using flux, Lead Solder)	over 95%	
Thermal Shock	JEITA ED-4701	0°C ~ 100°C	20 cycles	0/50
	300 307	15sec. 15sec.		
Temperature Cycle	JEITA ED-4701	-40° C ~ 25° C ~ 100° C ~ 25° C	100 cycles	0/50
	100 105	30min. 5min. 30min. 5min.	-	
Moisture Resistance Cyclic	JEITA ED-4701	25°C ~ 65°C ~ -10°C	10 cycles	0/50
	200 203	90%RH 24hrs./1cycle		
High Temperature Storage	JEITA ED-4701	Ta=100°C	1000 hrs.	0/50
	200 201			
Temperature Humidity	JEITA ED-4701	Ta=60°C, RH=90%	1000 hrs.	0/50
Storage	100 103			
Low Temperature Storage	JEITA ED-4701	Ta=-40°C	1000 hrs.	0/50
	200 202			
Steady State Operating Life		Ta=25°C, IF=30mA/one circuit	300 hrs.	0/50
Condition 1		Two circuits are lit simultaneously.		
Steady State Operating Life		Ta=25°C, IF=20mA/one circuit	1000 hrs.	0/50
Condition 2		Two circuits are lit simultaneously.		
Steady State Operating Life		Ta=85°C, IF=5mA/one circuit	1000 hrs.	0/50
of High Temperature		Two circuits are lit simultaneously.		
Steady State Operating Life		60°C, RH=90%, IF=15mA/one circuit	500 hrs.	0/50
of High Humidity Heat		Two circuits are lit simultaneously.		
Steady State Operating Life		Ta=-30°C, IF=20mA/one circuit	1000 hrs.	0/50
of Low Temperature		Two circuits are lit simultaneously.		
Vibration	JEITA ED-4701	100 ~ 2000 ~ 100Hz Sweep 4min.	48min.	0/50
	400 403	200m/s ²		
		3direction, 4cycles		

(2) CRITERIA FOR JUDGING DAMAGE

			Criteria for Judgement	
Item	Symbol	Test Conditions	Min.	Max.
Forward Voltage	VF	IF=20mA /one circuit	-	U.S.L.*)× 1.1
Reverse Current	Ir	VR=5V/one circuit	-	U.S.L.*) \times 2.0
		IF=20mA /one circuit		
Luminous Intensity	Iv	Two circuits are lit	L.S.L.**) \times 0.7	-
		simultaneously.		

*) U.S.L. : Upper Standard Level **) L.S.L. : Lower Standard Level

7.CAUTIONS

The LEDs are devices which are materialized by combining Blue LEDs and special phosphors. Consequently, the color of the LEDs is changed a little by an operating current. Care should be taken after due consideration when using LEDs.

(1) Moisture Proof Package

• When moisture is absorbed into the SMT package it may vaporize and expand during soldering. There is a possibility that this can cause exfoliation of the contacts and damage to the optical characteristics of the LEDs. For this reason, the moisture proof package is used to keep moisture to a minimum in the package.

• The moisture proof package is made of an aluminum moisture proof bag. A package of a moisture absorbent material (silica gel) is inserted into the aluminum moisture proof bag. The silica gel changes its color from blue to pink as it absorbs moisture.

(2) Storage

· Storage Conditions

Before opening the package :

The LEDs should be kept at 30°C or less and 90%RH or less. The LEDs should be used within a year. When storing the LEDs, moisture proof packaging with absorbent material (silica gel) is recommended.

After opening the package :

The LEDs should be kept at 30°C or less and 70%RH or less. The LEDs should be soldered within 168 hours (7days) after opening the package. If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with packages of moisture absorbent material (silica gel). It is also recommended to return the LEDs to the original moisture proof bag and to reseal the moisture proof bag again.

• If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : more than 24 hours at $65 \pm 5^{\circ}C$

- Nichia LED electrodes are silver plated copper alloy. The silver surface may be affected by environments which contain corrosive substances. Please avoid conditions which may cause the LED to corrode, tarnish or discolor. This corrosion or discoloration may cause difficulty during soldering operations. It is recommended that the User use the LEDs as soon as possible.
- Please avoid rapid transitions in ambient temperature, especially in high humidity environments where condensation can occur.

(3) Heat Generation

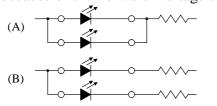
• Thermal design of the end product is of paramount importance. Please consider the heat generation of the LED when making the system design. The coefficient of temperature increase per input electric power is affected by the thermal resistance of the circuit board and density of LED placement on the board, as well as other components. It is necessary to avoid intense heat generation and operate within the maximum ratings given in this specification.

• The operating current should be decided after considering the ambient maximum temperature of LEDs.

(4) Recommended circuit

· Operating at constant current per LED is recommended.

In case of operating at constant voltage, circuit (B) is recommended. As for circuit (A), the current may not be stable because of the Forward Voltage characteristic of the LED.



(5) Soldering Conditions

 \cdot The LEDs can be soldered in place using the reflow soldering method. Nichia cannot make a guarantee on the LEDs after they have been assembled using the dip soldering method.

Reflow Soldering			Hand Soldering	
	Lead Solder	Lead-free Solder		
Pre-heat	120 ~ 150°C	180 ~ 200°C	Temperature	350°C Max.
Pre-heat time	120 sec. Max.	120 sec. Max.	Soldering time	3 sec. Max.
Peak temperature	240°C Max.	260°C Max.		(one time only)
Soldering time	10 sec. Max.	10 sec. Max.		
Condition	refer to	refer to		
	Temperature - profile ①.	Temperature - profile ②.		
		(N ₂ reflow is recommended.)		

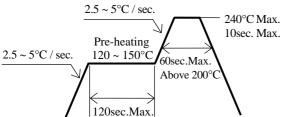
· Recommended soldering conditions

* Although the recommended soldering conditions are specified in the above table, reflow or hand soldering at the lowest possible temperature is desirable for the LEDs.

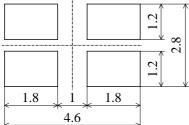
* A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.

[Temperature-profile (Surface of circuit board)]

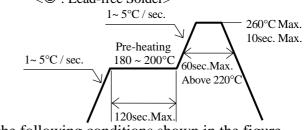
<1 : Lead Solder>



[Recommended soldering pad design]



Use the conditions shown to the under figure. <© : Lead-free Solder>



Use the following conditions shown in the figure.

• Occasionally there is a brightness decrease caused by the influence of heat or ambient atmosphere during air reflow. It is recommended that the User use the nitrogen reflow method.

(Unit:mm)

- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than two times.
- \cdot When soldering, do not put stress on the LEDs during heating.
- \cdot After soldering, do not warp the circuit board.

(6) Cleaning

- It is recommended that isopropyl alcohol be used as a solvent for cleaning the LEDs. When using other solvents, it should be confirmed beforehand whether the solvents will dissolve the package and the resin or not. Freon solvents should not be used to clean the LEDs because of worldwide regulations.
- Do not clean the LEDs by the ultrasonic. When it is absolutely necessary, the influence of ultrasonic cleaning on the LEDs depends on factors such as ultrasonic power and the assembled condition.
 Before cleaning, a pre-test should be done to confirm whether any damage to the LEDs will occur.

(7) Static Electricity

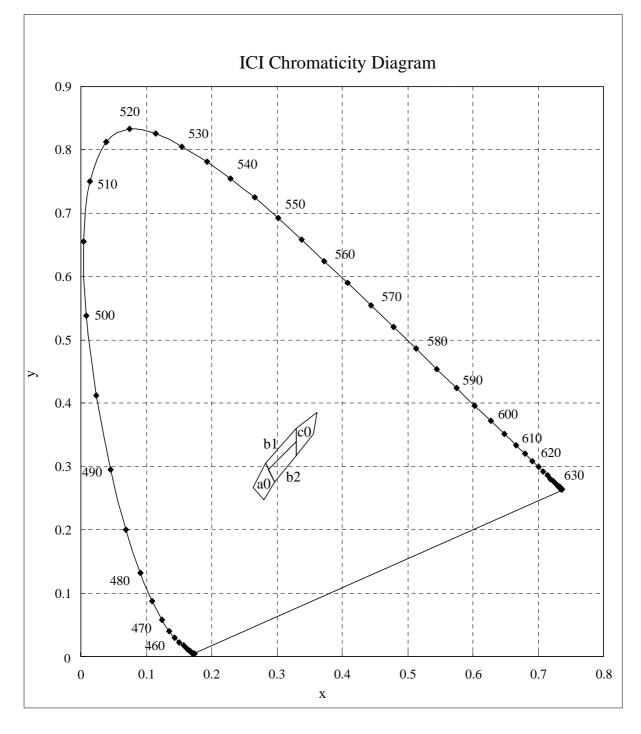
 \cdot Static electricity or surge voltage damages the LEDs.

- It is recommended that a wrist band or an anti-electrostatic glove be used when handling the LEDs.
- All devices, equipment and machinery must be properly grounded. It is recommended that precautions be taken against surge voltage to the equipment that mounts the LEDs.
- When inspecting the final products in which LEDs were assembled, it is recommended to check whether the assembled LEDs are damaged by static electricity or not. It is easy to find static-damaged LEDs by a light-on test or a VF test at a lower current (below 1mA is recommended).
- Damaged LEDs will show some unusual characteristics such as the leak current remarkably increases, the forward voltage becomes lower, or the LEDs do not light at the low current.

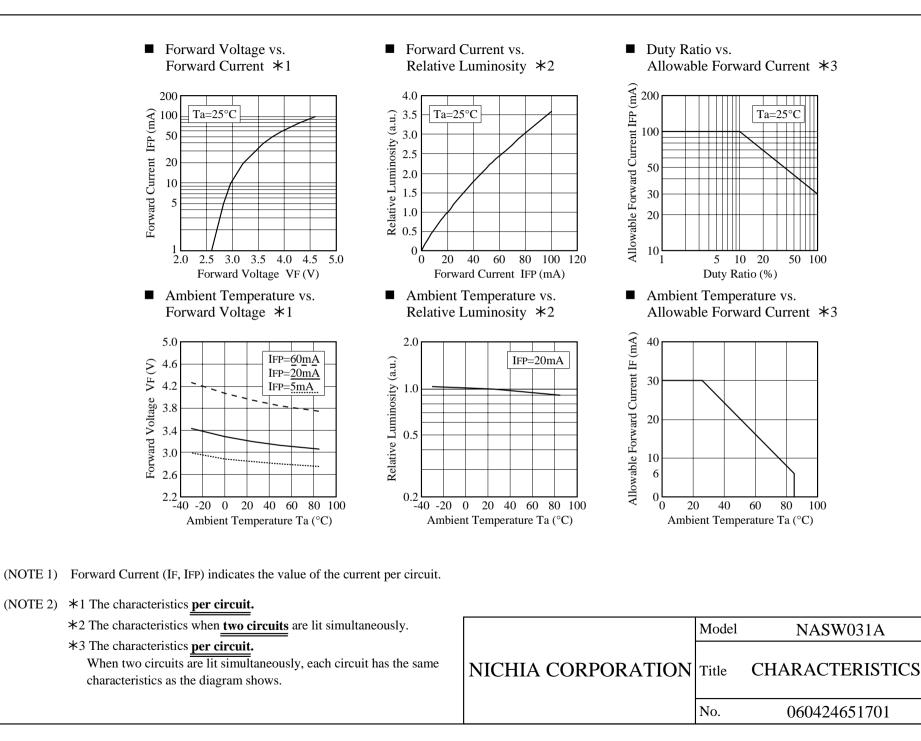
Criteria : (VF > 2.0V at IF=0.5mA)

(8) Others

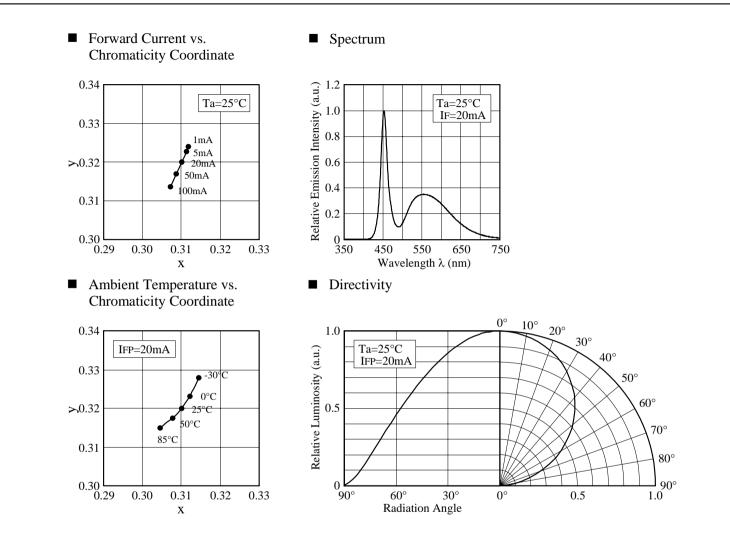
- \cdot NASW031A complies with RoHS Directive.
- \cdot Care must be taken to ensure that the reverse voltage will not exceed the absolute maximum rating when using the LEDs with matrix drive.
- \cdot The LED light output is strong enough to injure human eyes. Precautions must be taken to prevent looking directly at the LEDs with unaided eyes for more than a few seconds.
- Flashing lights have been known to cause discomfort in people; you can prevent this by taking precautions during use. Also, people should be cautious when using equipment that has had LEDs incorporated into it.
- The LEDs described in this brochure are intended to be used for ordinary electronic equipment (such as office equipment, communications equipment, measurement instruments and household appliances). Consult Nichia's sales staff in advance for information on the applications in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as for airplanes, aerospace, submersible repeaters, nuclear reactor control systems, automobiles, traffic control equipment, life support systems and safety devices).
- User shall not reverse engineer by disassembling or analysis of the LEDs without having prior written consent from Nichia. When defective LEDs are found, the User shall inform Nichia directly before disassembling or analysis.
- \cdot The formal specifications must be exchanged and signed by both parties before large volume purchase begins.
- \cdot The appearance and specifications of the product may be modified for improvement without notice.



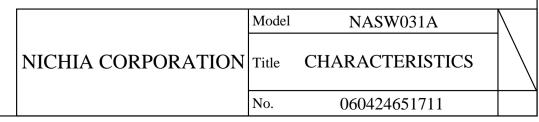
* Color Coordinates Measurement allowance is ± 0.01



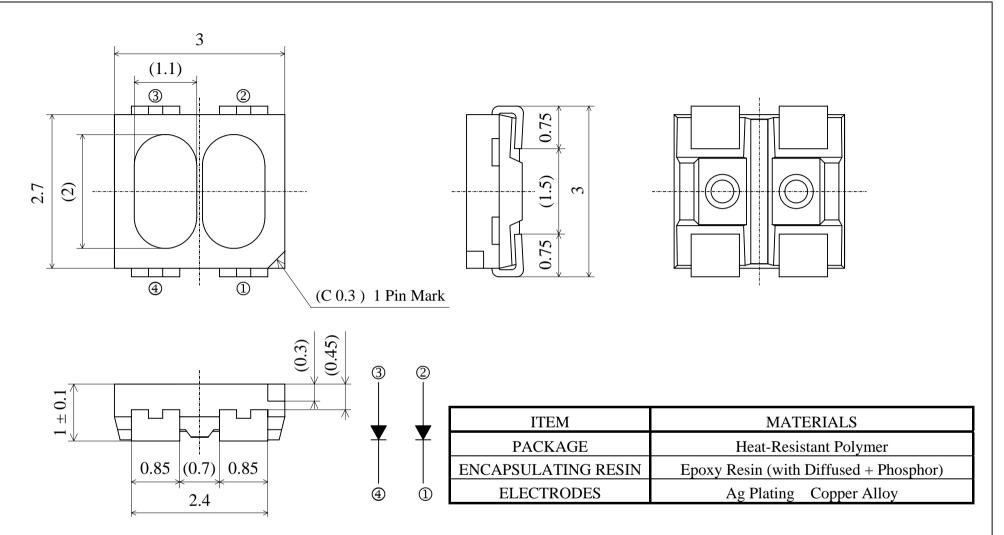
Nichia STSE-CC6053A <Cat.No.060509>



- (NOTE 1) Forward Current (IF, IFP) indicates the value of the current per circuit.
- (NOTE 2) The above indicates the characteristics when <u>two circuits</u> are lit simultaneously.



Nichia STSE-CC6053A <Cat.No.060509>

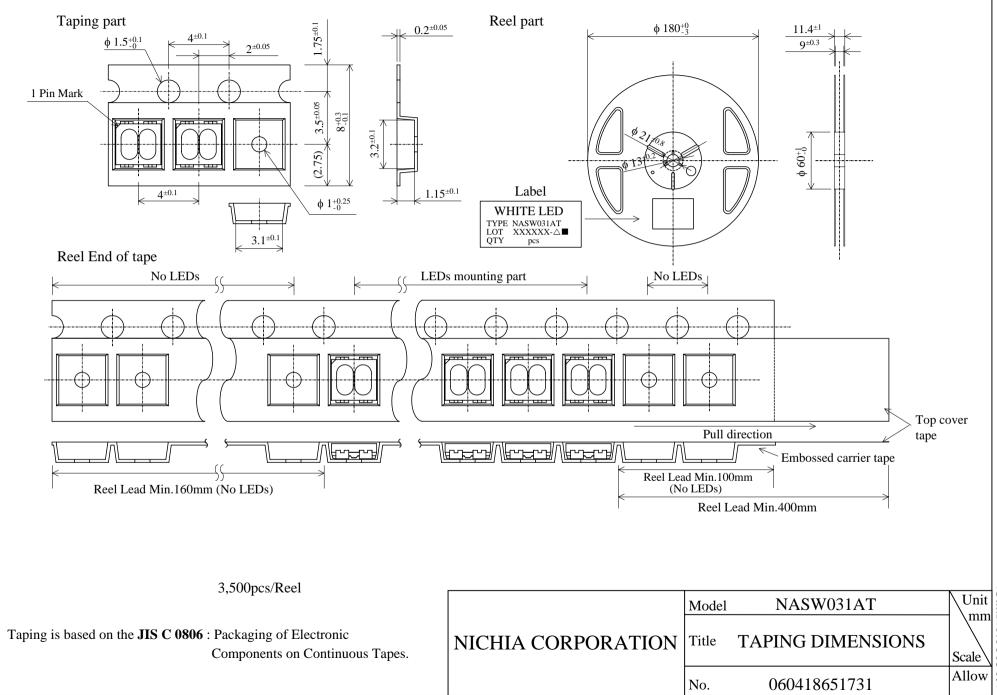


* The dice are mounted on the ① side and ③ side.

	Model	NASW031A	Unit
NICHIA CORPORATION	Title	OUTLINE DIMENSIONS	15/1 Scale
	No.	060418651721	Allow ±0.2

-10-

Nichia STSE-CC6053A <Cat.No.060509>



Nichia STSE-C6053A <Cat.No.060509>

